

MS74N62

P-Channel 60-V (D-S) MOSFET

Features

- Low $r_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed
- Low thermal impedance copper lead frame

DFN5X6-8L saves board space

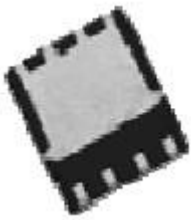
- RoHS compliant package

Typical Applications:

- White LED boost converters
- Automotive Systems
- Industrial DC/DC Conversion Circuits

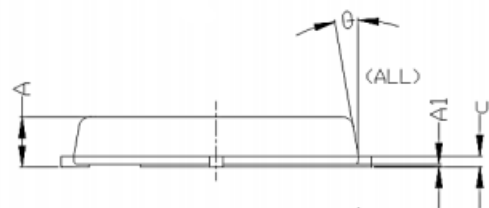
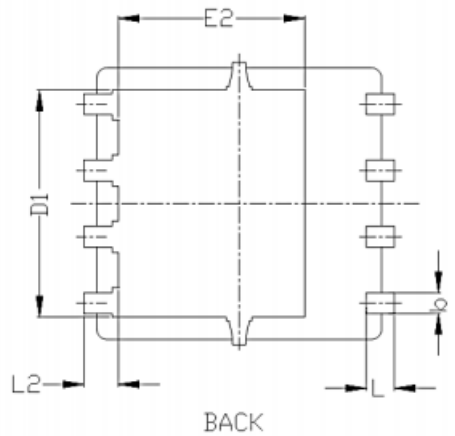
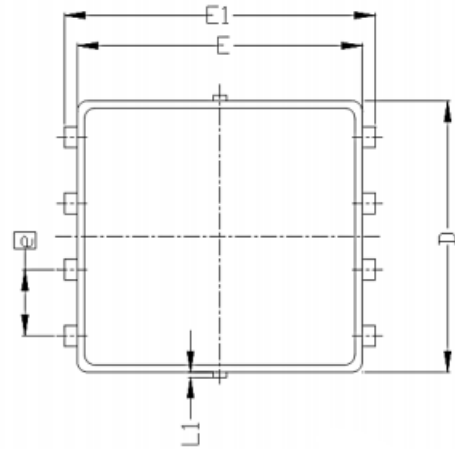
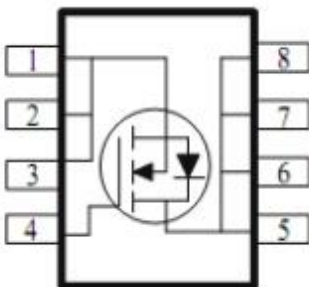
Packing & Order Information

3,000/Reel



**RoHS
COMPLIANT**

Graphic symbol



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
A1	0.00	—	0.05	0.000	—	0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
c	0.15	0.20	0.25	0.006	0.008	0.010
D	5.20 BSC			0.205 BSC		
D1	4.35 BSC			0.171 BSC		
E	5.55 BSC			0.219 BSC		
E1	6.05 BSC			0.238 BSC		
E2	3.62 BSC			0.143 BSC		
e	1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0	—	0.15	0	—	0.006
L2	0.68 REF			0.027 REF		
θ	0°	—	10°	0°	—	10°

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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current ^a ($T_A=25^\circ\text{C}$)	13	A
	Continuous Drain Current ^a ($T_A=70^\circ\text{C}$)	11	A
I_{DM}	Pulsed Drain Current ^b	50	A
I_S	Continuous Source Current (Diode Conduction) ^a	4.6	A
P_D	Power Dissipation ^a ($T_A=25^\circ\text{C}$)	5	W
	Power Dissipation ^a ($T_A=70^\circ\text{C}$)	3.2	W
T_J/T_{STG}	Operating Junction and Storage Temperature	-55 to +150	$^\circ\text{C}$

Thermal Resistance Ratings

Symbol	Parameter	Maximum	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient ^a ($t \leq 10$ sec)	25	$^\circ\text{C/W}$
	Maximum Junction-to-Ambient ^a (Steady-State)	65	

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

Static

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250\mu\text{A}$	1			V
I_{GSS}	Gate-Body Leakage	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48$ V, $V_{GS} = 0$ V $V_{DS} = 48$ V, $V_{GS} = 0$ V, $T_J = 55^\circ\text{C}$			1 25	μA
$I_{D(on)}$	On-State Drain Current	$V_{DS} = 5$ V, $V_{GS} = 10$ V	25			A
$r_{DS(on)}$	Drain-Source On-Resistance	$V_{GS} = 10$ V, $I_D = 10.4$ A $V_{GS} = 4.5$ V, $I_D = 7.2$ A			22 26	m Ω
g_{fs}	Forward Transconductance	$V_{GS} = 15$ V, $I_D = 10.4$ A		20		S
V_{SD}	Diode Forward Voltage	$I_S = 2.3$ A, $V_{GS} = 0$ V		0.7		V

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Dynamic						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
Q_g	Total Gate Charge	$V_{DS} = 30\text{ V}$, $I_D = 10.4\text{ A}$, $V_{GS} = 4.5\text{ V}$	--	20	--	nC
Q_{gs}	Gate-Source Charge		--	5.8	--	nC
Q_{gd}	Gate-Drain Charge		--	10	--	nC
$t_{d(on)}$	Turn-On Delay Time	$I_D = 10.4\text{ A}$, $R_L = 2.9\ \Omega$, $V_{GEN} = 10\text{ V}$, $R_{GEN} = 6\ \Omega$, $V_{DS} = 30\text{ V}$	--	10	--	ns
t_r	Rise Time		--	24	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	67	--	ns
t_f	Fall Time		--	37	--	ns
C_{ISS}	Input Capacitance	$V_{DS} = 15\text{ V}$ $f = 1\text{ MHz}$, $V_{GS} = 0\text{ V}$	--	2086	--	pF
C_{OSS}	Output Capacitance		--	174	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	160	--	pF

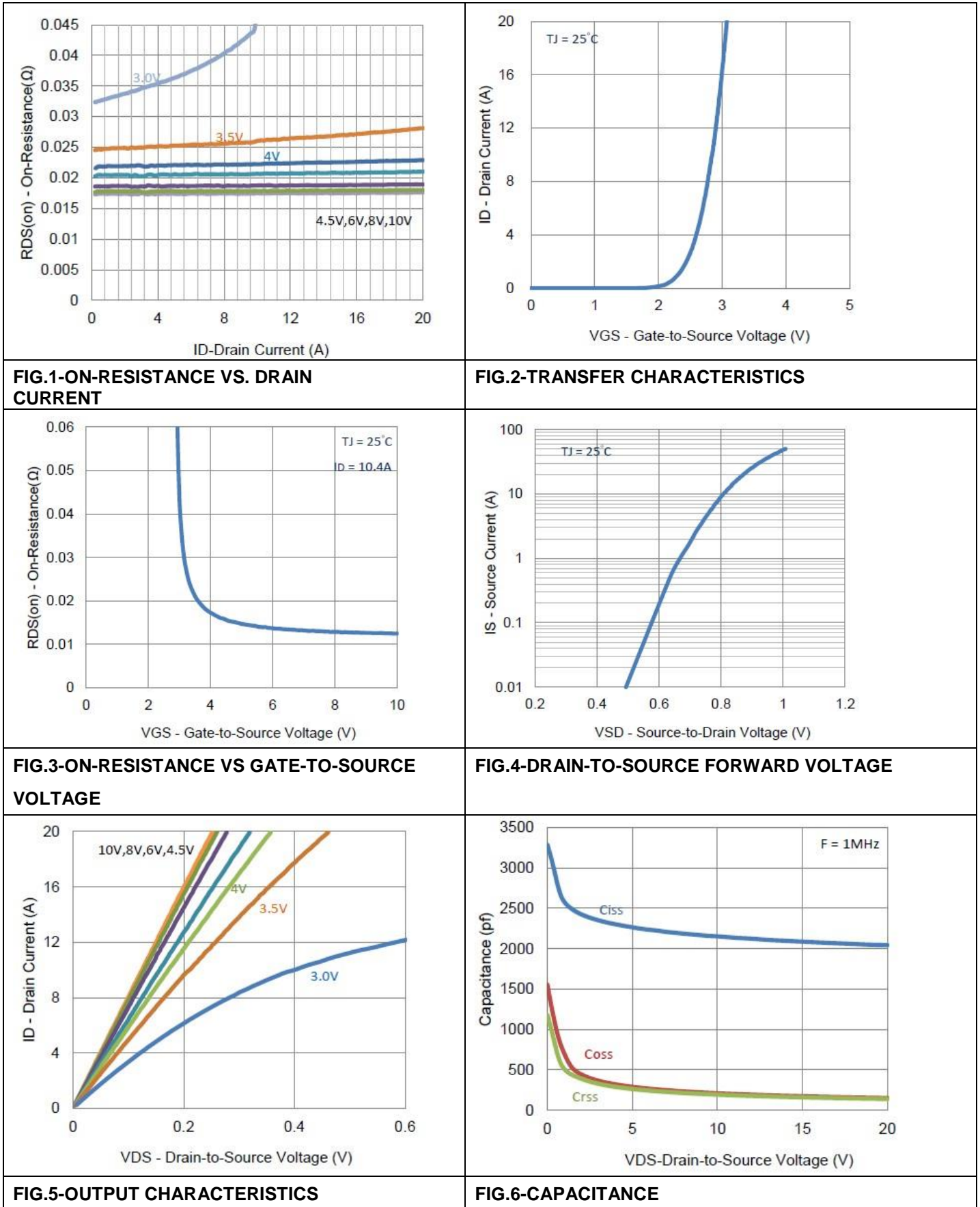
Notes

- Pulse test: $PW \leq 300\mu s$ duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics



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■ Typical Electrical Characteristics

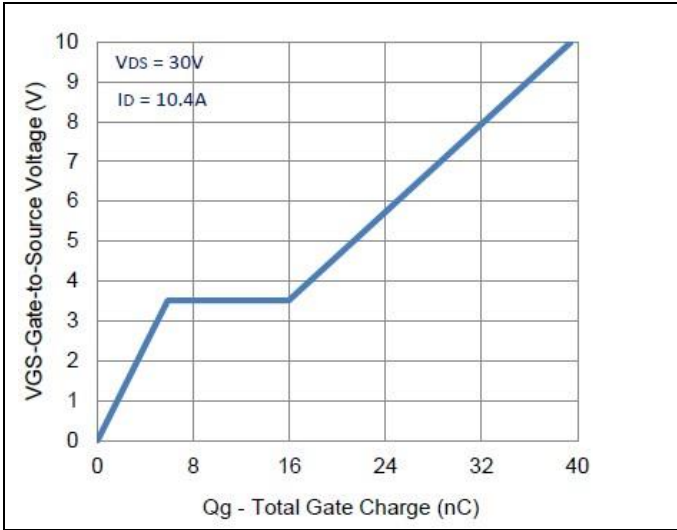


FIG.7-GATE CHARGE

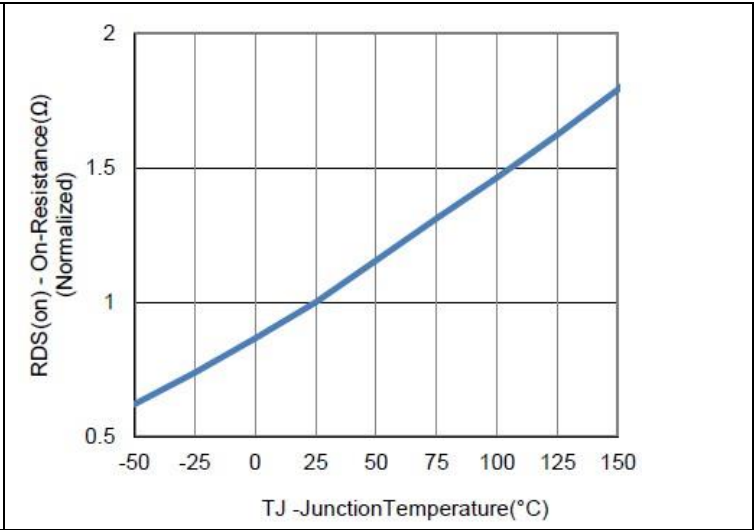


FIG.8-NORMALIZED ON-RESISTANCE VS JUNCTION TEMPERATURE

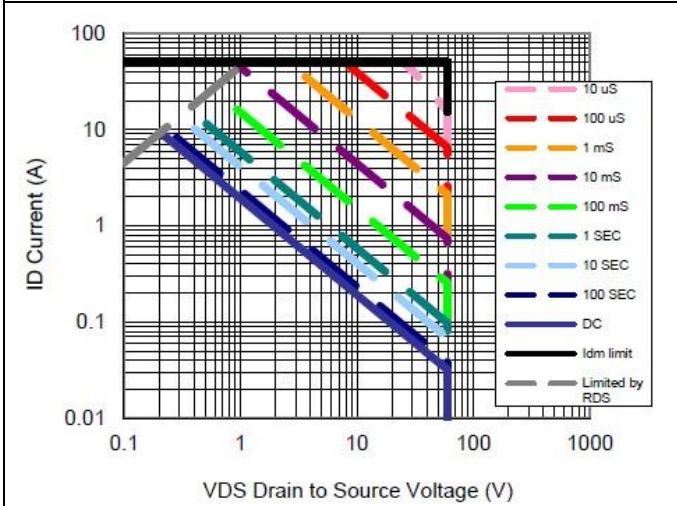


FIG.9-SAFE OPERATING AREA

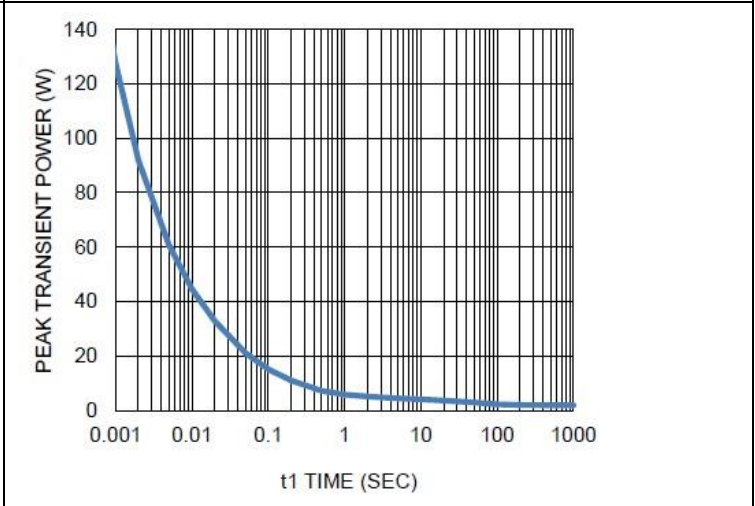


FIG.10-SINGLE PULSE MAXIMUM POWER DISSIPATION

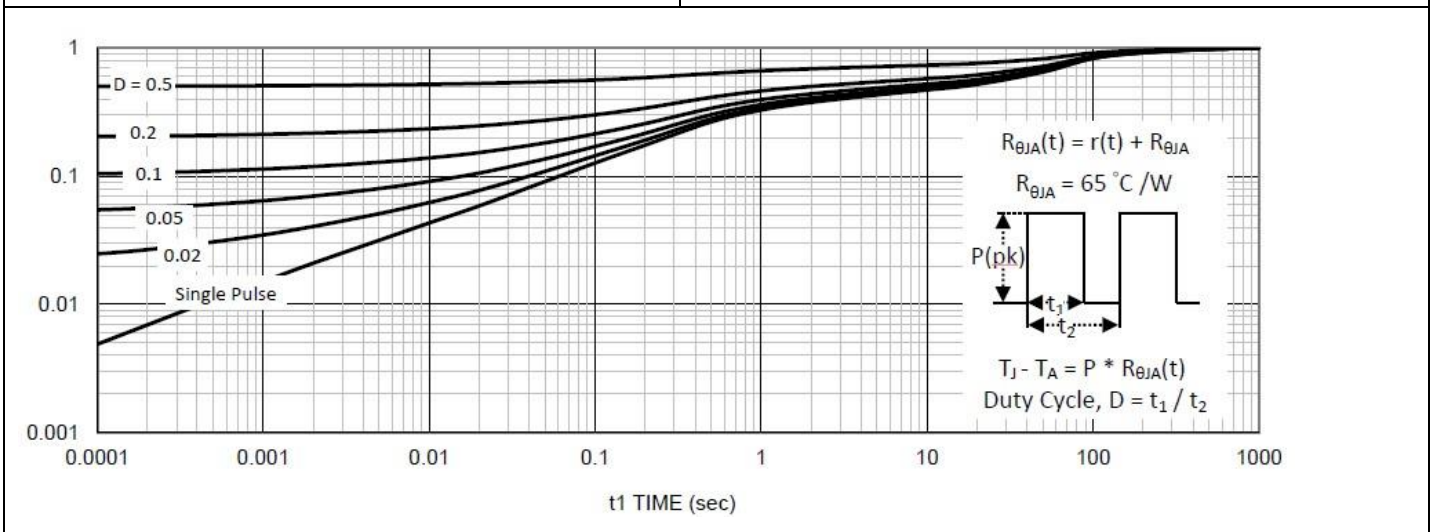


FIG.11-NORMALIZED THERMAL TRANSIENT JUNCTION TO AMBIENT

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